

Regulating Pulse Width Modulators

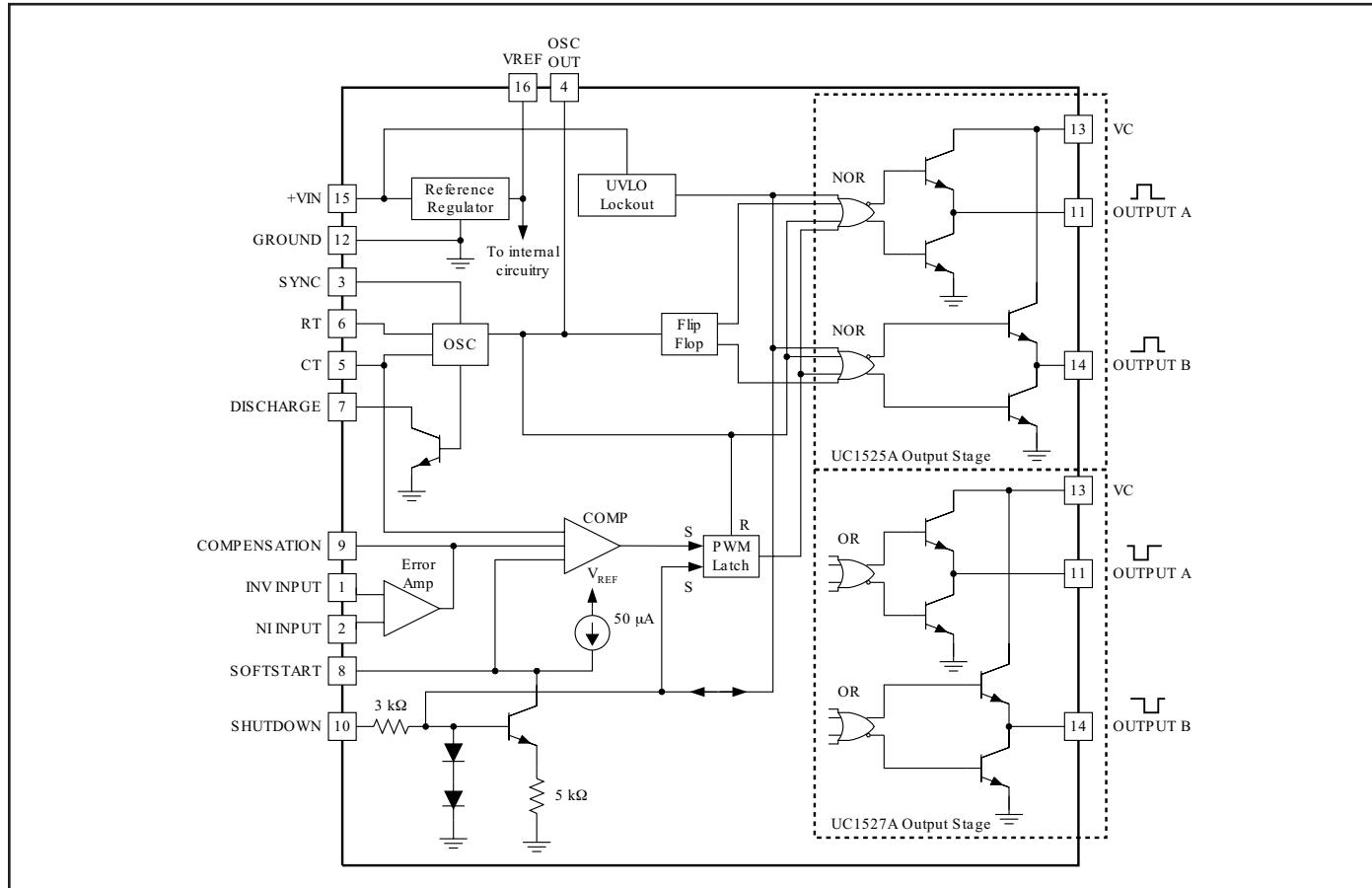
FEATURES

- 8 to 35V Operation
- 5.1V Reference Trimmed to $\pm 1\%$
- 100Hz to 500kHz Oscillator Range
- Separate Oscillator Sync Terminal
- Adjustable Deadtime Control
- Internal Soft-Start
- Pulse-by-Pulse Shutdown
- Input Undervoltage Lockout with Hysteresis
- Latching PWM to Prevent Multiple Pulses
- Dual Source/Sink Output Drivers

DESCRIPTION

The UC1525A/1527A series of pulse width modulator integrated circuits are designed to offer improved performance and lowered external parts count when used in designing all types of switching power supplies. The on-chip +5.1V reference is trimmed to $\pm 1\%$ and the input common-mode range of the error amplifier includes the reference voltage, eliminating external resistors. A sync input to the oscillator allows multiple units to be slaved or a single unit to be synchronized to an external system clock. A single resistor between the C_T and the discharge terminals provides a wide range of dead-time adjustment. These devices also feature built-in soft-start circuitry with only an external timing capacitor required. A shutdown terminal controls both the soft-start circuitry and the output stages, providing instantaneous turn off through the PWM latch with pulsed shutdown, as well as soft-start recycle with longer shutdown commands. These functions are also controlled by an undervoltage lockout which keeps the outputs off and the soft-start capacitor discharged for sub-normal input voltages. This lockout circuitry includes approximately 500mV of hysteresis for jitter-free operation. Another feature of these PWM circuits is a latch following the comparator. Once a PWM pulse has been terminated for any reason, the outputs will remain off for the duration of the period. The latch is reset with each clock pulse. The output stages are totem-pole designs capable of sourcing or sinking in excess of 200mA. The UC1525A output stage features NOR logic, giving a LOW output for an OFF state. The UC1527A utilizes OR logic which results in a HIGH output level when OFF.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS(Note 1)

Supply Voltage, ($+V_{IN}$)	+40V
Collector Supply Voltage (V_C)	+40V
Logic Inputs	-0.3V to +5.5V
Analog Inputs	-0.3V to $+V_{IN}$
Output Current, Source or Sink	500mA
Reference Output Current	50mA
Oscillator Charging Current	5mA
Power Dissipation at $T_A = +25^\circ C$ (Note 2)	1000mW
Power Dissipation at $T_C = +25^\circ C$ (Note 2)	2000mW
Operating Junction Temperature	-55°C to +150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10 seconds)	+300°C

Note 1: Values beyond which damage may occur.

Note 2: Consult packaging Section of Databook for thermal limitations and considerations of package.

RECOMMENDED OPERATING CONDITIONS

(Note 3)

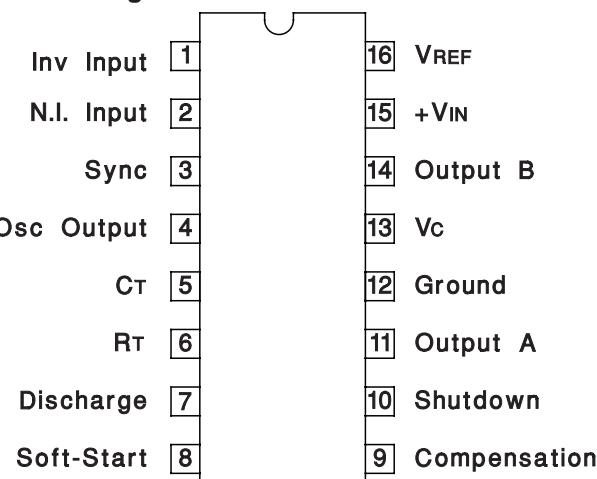
Input Voltage ($+V_{IN}$)	+8V to +35V
Collector Supply Voltage (V_C)	+4.5V to +35V
Sink/Source Load Current (steady state)	0 to 100mA
Sink/Source Load Current (peak)	0 to 400mA
Reference Load Current	0 to 20mA
Oscillator Frequency Range	100Hz to 400kHz
Oscillator Timing Resistor	2kΩ to 150kΩ
Oscillator Timing Capacitor001μF to .01μF
Dead Time Resistor Range	0 to 500Ω
Operating Ambient Temperature Range	

UC1525A, UC1527A	-55°C to +125°C
UC2525A, UC2527A	-25°C to +85°C
UC3525A, UC3527A	0°C to +70°C

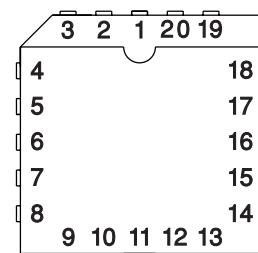
Note 3: Range over which the device is functional and parameter limits are guaranteed.

CONNECTION DIAGRAMS**DIL-16 (TOP VIEW)**

J or N Package

**PLCC-20, LCC-20 (TOP VIEW)**

Q, L Package



PACKAGE PIN FUNCTION	
FUNCTION	PIN
N/C	1
Inv. Input	2
N.I. Input	3
SYNC	4
OSC. output	5
N/C	6
C _T	7
R _T	8
Discharge	9
Softstart	10
N/C	11
Compensation	12
Shutdown	13
Output A	14
Ground	15
N/C	16
V _C	17
Output B	18
+V _{IN}	19
V _{REF}	20

UC1525A/27A

UC2525A/27A

UC3525A/27A

ELECTRICAL CHARACTERISTICS: $+V_{IN} = 20V$, and over operating temperature, unless otherwise specified, $T_A = T_J$.

PARAMETER	TEST CONDITIONS	UC1525A/UC2525A UC1527A/UC2527A			UC3525A UC3527A			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Reference Section								
Output Voltage	$T_J = 25^\circ C$	5.05	5.10	5.15	5.00	5.10	5.20	V
Line Regulation	$V_{IN} = 8$ to $35V$		10	20		10	20	mV
Load Regulation	$I_L = 0$ to $20mA$		20	50		20	50	mV
Temperature Stability (Note 5)	Over Operating Range		20	50		20	50	
Total Output Variation (Note 5)	Line, Load, and Temperature	5.00		5.20	4.95		5.25	V
Shorter Circuit Current	$V_{REF} = 0$, $T_J = 25^\circ C$		80	100		80	100	mA
Output Noise Voltage (Note 5)	$10Hz \leq 10kHz$, $T_J = 25^\circ C$		40	200		40	200	μV_{rms}
Long Term Stability (Note 5)	$T_J = 125^\circ C$		20	50		20	50	mV
Oscillator Section (Note 6)								
Initial Accuracy (Notes 5 & 6)	$T_J = 25^\circ C$		± 2	± 6		± 2	± 6	%
Voltage Stability (Notes 5 & 6)	$V_{IN} = 8$ to $35V$		± 0.3	± 1		± 1	± 2	%
Temperature Stability (Note 5)	Over Operating Range		± 3	± 6		± 3	± 6	%
Minimum Frequency	$R_T = 200k\Omega$, $C_T = 0.1\mu F$			120			120	Hz
Maximum Frequency	$R_T = 2k\Omega$, $C_T = 470pF$	400			400			kHz
Current Mirror	$I_{RT} = 2mA$	1.7	2.0	2.2	1.7	2.0	2.2	mA
Clock Amplitude (Notes 5 & 6)		3.0	3.5		3.0	3.5		V
Clock Width (Notes 5 & 6)	$T_J = 25^\circ C$	0.3	0.5	1.0	0.3	0.5	1.0	μs
Sync Threshold		1.2	2.0	2.8	1.2	2.0	2.8	V
Sync Input Current	Sync Voltage = $3.5V$		1.0	2.5		1.0	2.5	mA
Error Amplifier Section ($V_{CM} = 5.1V$)								
Input Offset Voltage			0.5	5		2	10	mV
Input Bias Current			1	10		1	10	μA
Input Offset Current				1			1	μA
DC Open Loop Gain	$R_L \geq 10M\Omega$	60	75		60	75		dB
Gain-Bandwidth Product (Note 5)	$A_V = 0dB$, $T_J = 25^\circ C$	1	2		1	2		MHz
DC Transconductance (Notes 5 & 7)	$T_J = 25^\circ C$, $30k\Omega \leq R_L \leq 1M\Omega$	1.1	1.5		1.1	1.5		mS
Output Low Level			0.2	0.5		0.2	0.5	V
Output High Level		3.8	5.6		3.8	5.6		V
Common Mode Rejection	$V_{CM} = 1.5$ to $5.2V$	60	75		60	75		dB
Supply Voltage Rejection	$V_{IN} = 8$ to $35V$	50	60		50	60		dB

Note 5: These parameters, although ensured over the recommended operating conditions, are not 100% tested in production.

Note 6: Tested at $f_{osc} = 40kHz$ ($R_T = 3.6k\Omega$, $C_T = 0.01\mu F$, $R_D = 0\Omega$). Approximate oscillator frequency is defined by:

$$f = \frac{1}{C_T (0.7R_T + 3R_D)}$$

Note 7: DC transconductance (g_M) relates to DC open-loop voltage gain (A_V) according to the following equation: $A_V = g_M R_L$ where R_L is the resistance from pin 9 to ground. The minimum g_M specification is used to calculate minimum A_V when the error amplifier output is loaded.

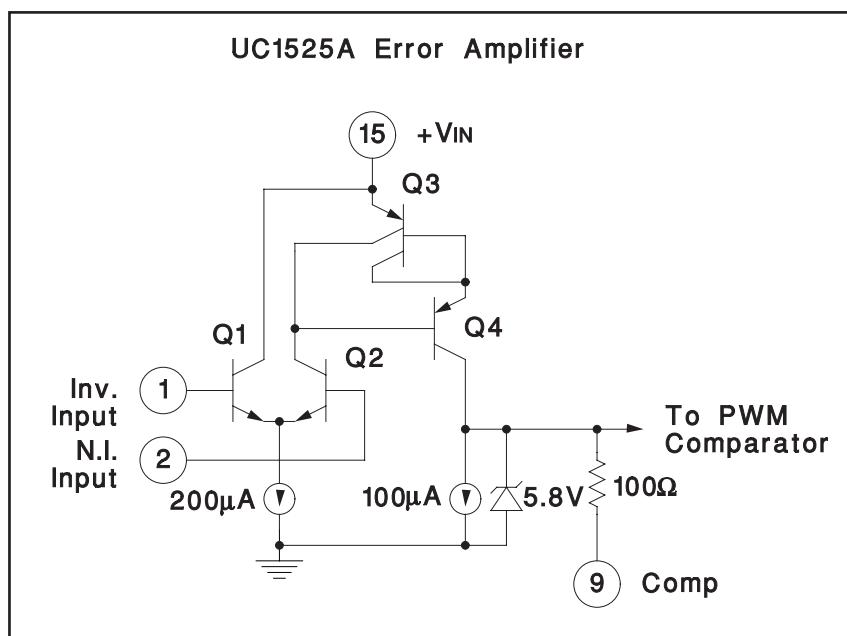
ELECTRICAL CHARACTERISTICS: $+V_{IN} = 20V$, and over operating temperature, unless otherwise specified, $T_A = T_J$.

PARAMETER	TEST CONDITIONS	UC1525A/UC2525A UC1527A/UC2527A			UC3525A UC3527A			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
PWM Comparator								
Minimum Duty-Cycle				0			0	%
Maximum Duty-Cycle (Note 6)		45	49		45	49		%
Input Threshold (Note 6)	Zero Duty-Cycle	0.7	0.9		0.7	0.9		V
	Maximum Duty-Cycle		3.3	3.6		3.3	3.6	V
Input Bias Current (Note 5)			.05	1.0		.05	1.0	μA
Shutdown Section								
Soft Start Current	$V_{SD} = 0V, V_{SS} = 0V$	25	50	80	25	50	80	μA
Soft Start Low Level	$V_{SD} = 2.5V$		0.4	0.7		0.4	0.7	V
Shutdown Threshold	To outputs, $V_{SS} = 5.1V, T_J = 25^\circ C$	0.6	0.8	1.0	0.6	0.8	1.0	V
Shutdown Input Current	$V_{SD} = 2.5V$		0.4	1.0		0.4	1.0	mA
Shutdown Delay (Note 5)	$V_{SD} = 2.5V, T_J = 25^\circ C$		0.2	0.5		0.2	0.5	μs
Output Drivers (Each Output) ($V_C = 20V$)								
Output Low Level	$I_{SINK} = 20mA$		0.2	0.4		0.2	0.4	V
	$I_{SINK} = 100mA$		1.0	2.0		1.0	2.0	V
Output High Level	$I_{SOURCE} = 20mA$	18	19		18	19		V
	$I_{SOURCE} = 100mA$	17	18		17	18		V
Under-Voltage Lockout	V_{COMP} and $V_{SS} = \text{High}$	6	7	8	6	7	8	V
V_C OFF Current (Note 7)	$V_C = 35V$		200			200		μA
Rise Time (Note 5)	$C_L = 1nF, T_J = 25^\circ C$		100	600		100	600	ns
Fall Time (Note 5)	$C_L = 1nF, T_J = 25^\circ C$		50	300		50	300	ns
Total Standby Current								
Supply Current	$V_{IN} = 35V$		14	20		14	20	mA

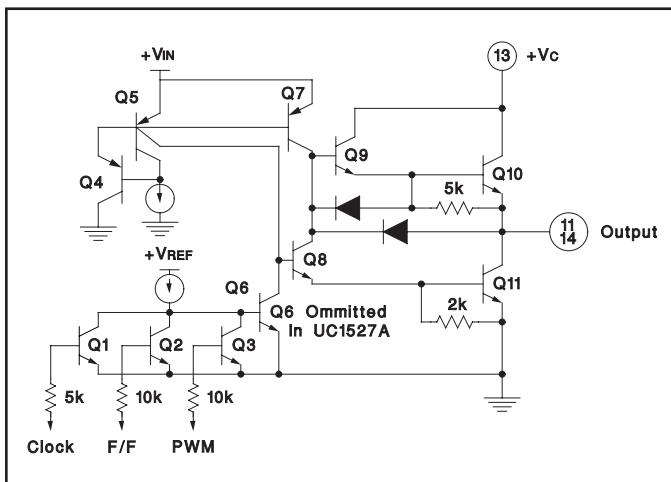
Note 5: These parameters, although ensured over the recommended operating conditions, are not 100% tested in production.

Note 6: Tested at $f_{OSC} = 40kHz$ ($R_T = 3.6k\Omega$, $C_T = 0.01\mu F$, $R_D = 0\Omega$)

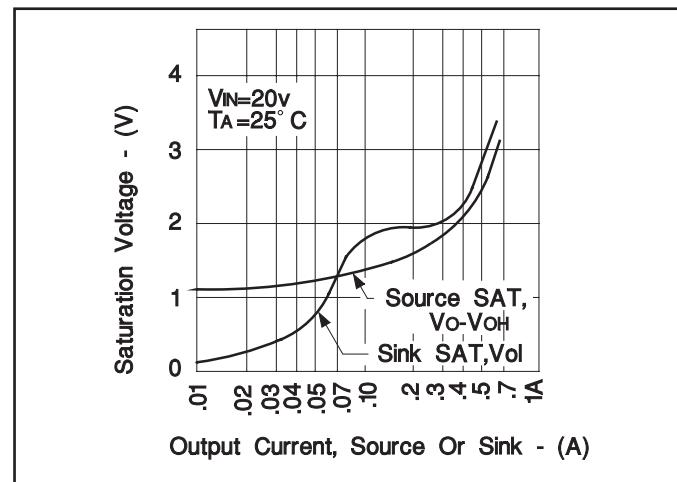
Note 7: Collector off-state quiescent current measured at pin 13 with outputs low for UC1525A and high for UC1527A.



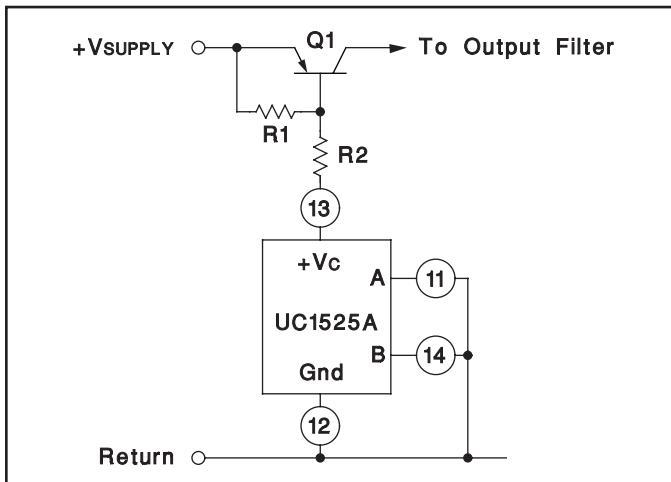
PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS



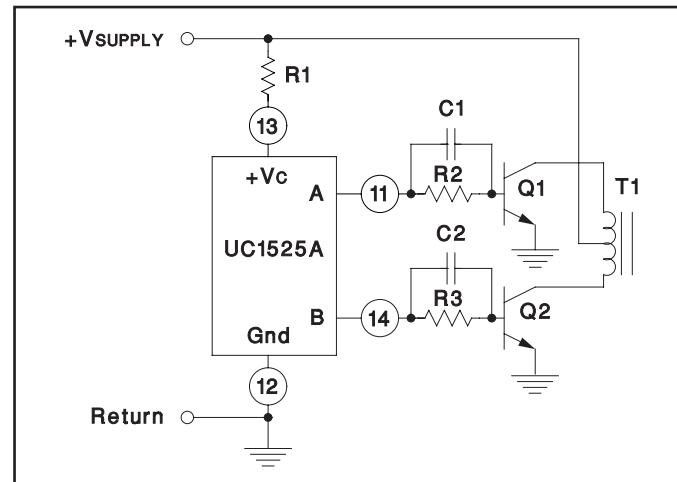
UC1525A output circuit (1/2 circuit shown).



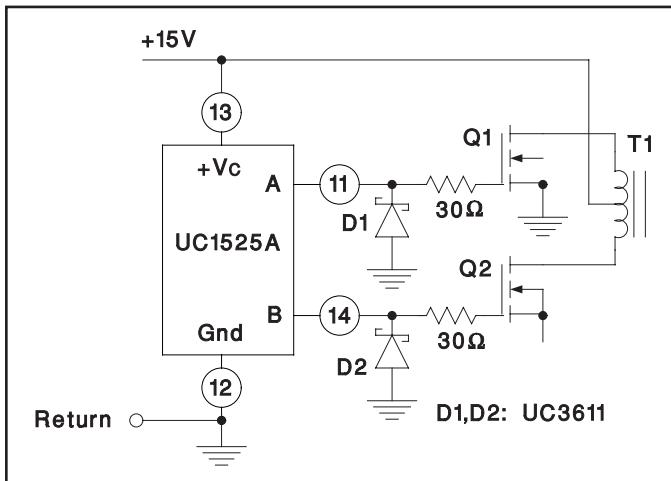
UC1525A output saturation characteristics.



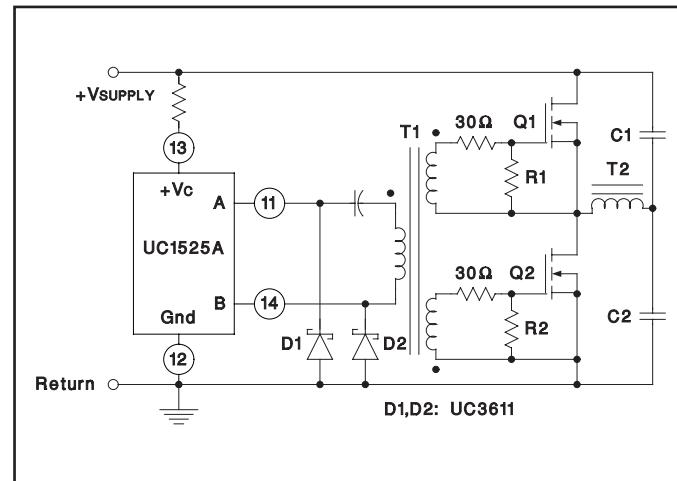
For single-ended supplies, the driver outputs are grounded. The V_C terminal is switched to ground by the totem-pole source transistors on alternate oscillator cycles.



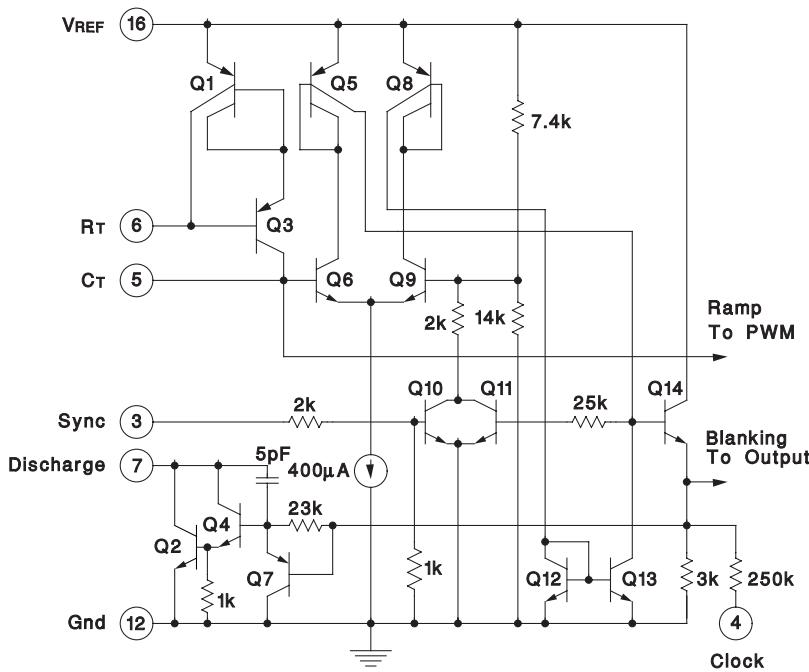
In conventional push-pull bipolar designs, forward base drive is controlled by R₁-R₃. Rapid turn-off times for the power devices are achieved with speed-up capacitors C₁ and C₂.



The low source impedance of the output drivers provides rapid charging of power FET Input capacitance while minimizing external components.



Low power transformers can be driven by the UC1525A. Automatic reset occurs during dead time, when both ends of the primary winding are switched to ground.



UC1525A oscillator schematic.

PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTIC SHUTDOWN OPTIONS

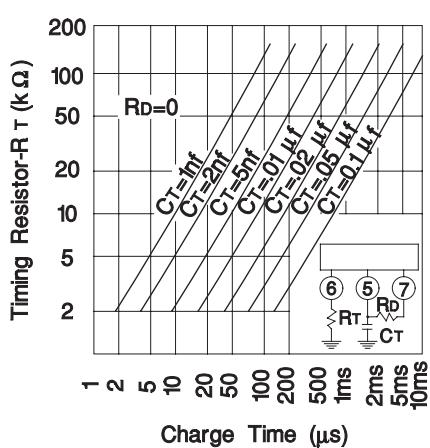
(See Block Diagram)

Since both the compensation and soft-start terminals (Pins 9 and 8) have current source pull-ups, either can readily accept a pull-down signal which only has to sink a maximum of $100\mu\text{A}$ to turn off the outputs. This is subject to the added requirement of discharging whatever external capacitance may be attached to these pins.

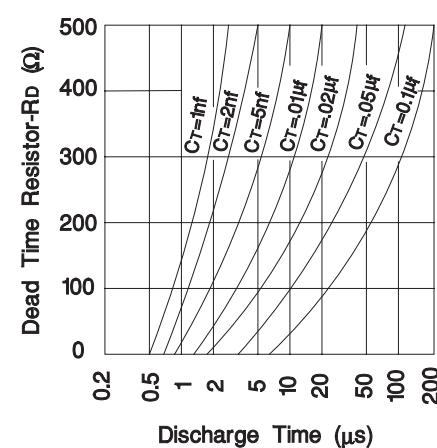
An alternate approach is the use of the shutdown circuitry of Pin 10 which has been improved to enhance the available shutdown options. Activating this circuit by applying a positive signal on Pin 10 performs two functions; the

PWM latch is immediately set providing the fastest turn-off signal to the outputs; and a $150\mu\text{A}$ -current sink begins to discharge the external soft-start capacitor. If the shutdown command is short, the PWM signal is terminated without significant discharge of the soft-start capacitor, thus, allowing, for example, a convenient implementation of pulse-by-pulse current limiting. Holding Pin 10 high for a longer duration, however, will ultimately discharge this external capacitor, recycling slow turn-on upon release.

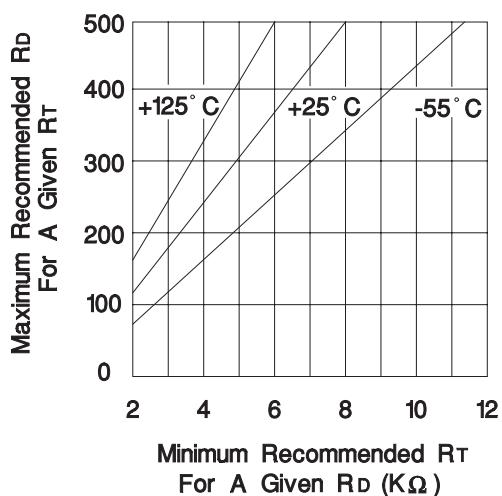
Pin 10 should not be left floating as noise pickup could conceivably interrupt normal operation.



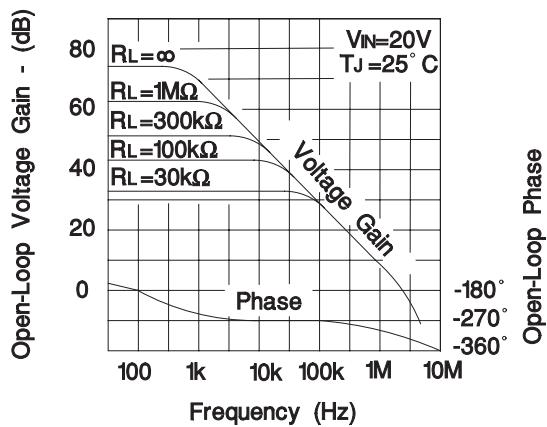
Oscillator Charge Time vs R_T and C_T .



Oscillator Discharge Time vs R_D and C_T .

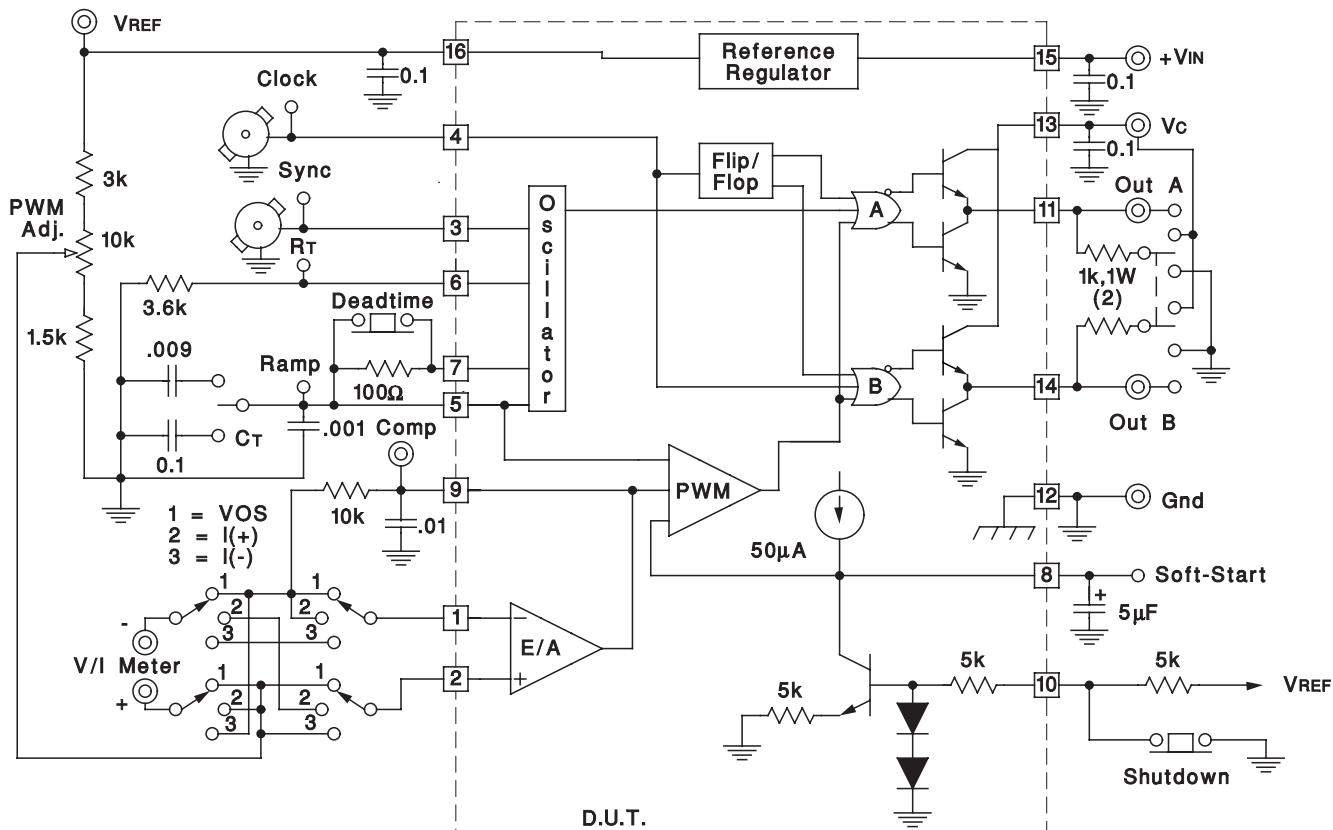


Maximum value R_D vs minimum value R_T .



R_L is impedance from pin 9 to ground. Values below 30kΩ will begin to limit the maximum duty cycle.

Error amplifier voltage gain and phase vs frequency.



Lab test fixture.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-89511012A	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
5962-89511032A	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
5962-89511035A	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
5962-89511042A	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
5962-89511045A	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1525AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1525AJ883B	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1525AL	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
UC1525AL/81197	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
UC1525AL883B	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
UC1527AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1527AJ883B	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1527AL883B	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
UC2525ADW	ACTIVE	SOIC	DW	16	40	None	CU NIPDAU	Level-2-220C-1 YEAR
UC2525ADWTR	ACTIVE	SOIC	DW	16	2000	None	CU NIPDAU	Level-2-220C-1 YEAR
UC2525AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC2525AJ/81046	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC2525AN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA
UC2525AQ	ACTIVE	PLCC	FN	20	46	None	CU SNPB	Level-2-220C-1 YEAR
UC2525AQTR	ACTIVE	PLCC	FN	20	1000	None	CU SNPB	Level-2-220C-1 YEAR
UC2525BDW	ACTIVE	SOIC	DW	16	40	None	CU NIPDAU	Level-2-220C-1 YEAR
UC2525BJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC2525BN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA
UC2527AN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA
UC3525ADW	ACTIVE	SOIC	DW	16	40	None	CU NIPDAU	Level-2-220C-1 YEAR
UC3525ADWTR	ACTIVE	SOIC	DW	16	2000	None	CU NIPDAU	Level-2-220C-1 YEAR
UC3525AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC3525AN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA
UC3525AQ	ACTIVE	PLCC	FN	20	46	None	CU SNPB	Level-2-220C-1 YEAR
UC3525AQTR	ACTIVE	PLCC	FN	20	1000	None	CU SNPB	Level-2-220C-1 YEAR
UC3527AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC3527AN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

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at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

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